



美 麗 微 半 導 體 股 份 有 限 公 司
F O R M O S A M I C R O S E M I C O . , L T D .
W e b s i t e : w w w . f o r m o s a m s . c o m

Declaration of SVHC Substances

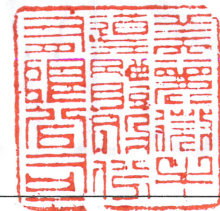
美麗微半導體股份有限公司特此宣告我司產品除玻封封裝及焊錫製程[▲]產品外，符合 SVHC 候選清單物質 REACH 240 項(含有濃度<0.1%)。

Formosa Microsemi Co. Ltd. hereby declares that our products, except assembled in glass packages & produced with solder[▲], comply with candidate list of 240 substances of very high concern for authorization (SVHC) under REACH (concentration of < 0.1%).

[▲]: 我司玻封封裝產品及焊錫製程產品符合 Rohs 2011/65/EU 排外條款 7(C)-I & 7(a)。玻封封裝產品因成份因素會含有>0.1%之三氧化二硼(Cas No. 1303-86-2)。

[▲]: Our Glass tube package products and Solder processed products comply with Rohs exemption 7(C)-I & 7(a) of 2011/65/EU. Due to raw ingredient, Glass tube package products contain more than 0.1% concentration Diboron Trioxide(B2O3,Cas No. 1303-86-2).

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Formosa Microsemi Co., Ltd.



Mar., 15th., 2024.